

COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	BV _{DSS}	R _{DS(ON)}	Ι _D T _A = +25°C
Q1	20V	35mΩ @ V _{GS} = 4.5V	4.5A
QI	200	56mΩ @ V _{GS} = 1.8V	3.5A
00	Q2 -20V	74mΩ @ V _{GS} = -4.5V	-3.1A
QZ		168mΩ @ V _{GS} = -1.8V	-2.0A

Description

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Motor Control
- Power Management Functions
- DC-DC Converters
- Backlighting

TSOT26



Top View

52 2 G2 3 Top View

Pin Configuration

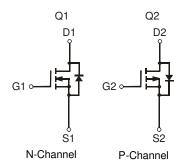
G1 1

Features

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 ⁽²⁾
- Terminal Connections Indicator: See Diagram
- Weight: 0.013 grams (Approximate)



Ordering Information (Note 5)

	Part Number	Compliance	Case	Packaging			
	DMC2038LVT-7 Standard		TSOT26	3000/Tape & Reel			
Notes:	Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS). 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.						

6 D1

5 S1

4 D2

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

 Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to https://www.diodes.com/quality/.

5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

	Π	\square	
310		ΥM	

31C = Product Type Marking Code YM = Date Code Marking Y = Year (ex: F = 2018)

M = Month (ex: 9 = September)

Date Code Key												
Year	2017	7	2018		2019	20	20	2021		2022	2	2023
Code	E		F		G	ŀ	4			J		К
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings N-CHANNEL - Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V _{DSS}	20	V
Gate-Source Voltage			V _{GSS}	±12	V
		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	3.7 3.0	A
Continuous Drain Current (Note 6) $V_{GS} = 4.5V$	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	4.1 3.2	А
	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	4.5 3.6	А
Continuous Drain Current (Note 7) $V_{GS} = 4.5V$	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	5.2 4.2	A
Maximum Continuous Body Diode Forward Current (Note 7)			Is	1.5	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	25	A

Maximum Ratings P-CHANNEL – Q2 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V _{DSS}	-20	V
Gate-Source Voltage			V _{GSS}	±12	V
		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	-2.6 -2.1	A
Continuous Drain Current (Note 6) V _{GS} = -4.5V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	-2.9 -2.4	A
	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	-3.1 -2.5	A
Continuous Drain Current (Note 7) $V_{GS} = -4.5V$	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	-3.8 -3.0	А
Maximum Continuous Body Diode Forward Current (Note 7)			ls	-1.5	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	-17	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	P	0.8	W
	$T_A = +70^{\circ}C$	PD	0.5	vv
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D	168	°C/W
Thermal Resistance, Junction to Amblent (Note 6)	t<10s	$R_{ heta JA}$	120	0/22
Total Dawar Dissinction (Nata 7)	$T_A = +25^{\circ}C$	Р	1.1	W
Total Power Dissipation (Note 7)	$T_A = +70^{\circ}C$	PD	0.7	vv
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	Р	114	
memai resistance, sunction to Ambient (note 7)	t<10s	$R_{\theta JA}$	72	°C/W
Thermal Resistance, Junction to Case (Note 7)	R _{eJC}	39		
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

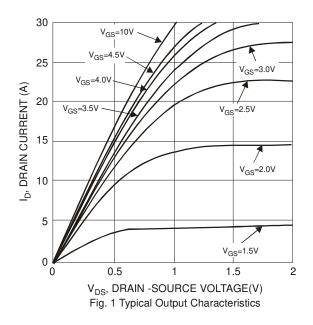
 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

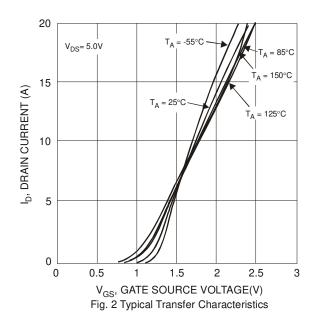


Electrical Characteristics N-CHANNEL – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Tym	Мах	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)	Symbol	IVIIII	Тур	Widx	Unit	Test Condition
Drain-Source Breakdown Voltage	BV _{DSS}	20	_	I	V	V _{GS} = 0V, I _D = 250µA
Zero Gate Voltage Drain Current $@T_C = +25^{\circ}C$				1.0	μA	$V_{GS} = 0V, ID = 230\mu A$ $V_{DS} = 16V, V_{GS} = 0V$
	I _{DSS}				nA	
Gate-Source Leakage ON CHARACTERISTICS (Note 8)	I _{GSS}	_	_	±100	ΠA	$V_{GS} = \pm 12V, V_{DS} = 0V$
				10		
Gate Threshold Voltage	V _{GS(TH)}	0.4	_	1.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
			27	35	-	$V_{GS} = 4.5V, I_D = 4.0A$
Static Drain-Source On-Resistance	R _{DS(ON)}	—	33	43	mΩ	$V_{GS} = 2.5V, I_D = 2.5A$
			43	56		$V_{GS} = 1.8V, I_D = 1.5A$
Forward Transfer Admittance	Y _{fs}	_	9	—	S	$V_{DS}=5V,\ I_D=3.4A$
Diode Forward Voltage	V _{SD}	0.4	_	1.1	V	$V_{GS} = 0V, I_S = 1A$
DYNAMIC CHARACTERISTICS (Note 9)				•	•	÷
Input Capacitance	Ciss	—	400	530	pF	
Output Capacitance	Coss	_	70	90	pF	$V_{DS} = 10V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	65	100	pF	
Gate Resistance	Rg	_	1.9	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	5.7	—	nC	
Total Gate Charge (V _{GS} = 10V)	Qg	_	12	17	nC	
Gate-Source Charge	Q _{gs}	_	0.7	—	nC	$V_{DS} = 15V, I_D = 5.8A$
Gate-Drain Charge	Q _{gd}	_	1.4	—	nC	
Turn-On Delay Time	t _{D(ON)}		5	10	ns	
Turn-On Rise Time	t _R		8	16	ns	V _{DS} = 10V, V _{GS} = 4.5V,
Turn-Off Delay Time	t _{D(OFF)}		25	40	ns	$R_G = 6\Omega$, $I_{DS} = 1A$
Turn-Off Fall Time	tF	—	8	16	ns	

Notes: 8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing.









 $T_A = 150^{\circ}C$

T_A = −55°C

20

T_A = 125°C

T_A = 25°C

V_{GS}=5V I_D=5A

50

75

T_A= 25°C

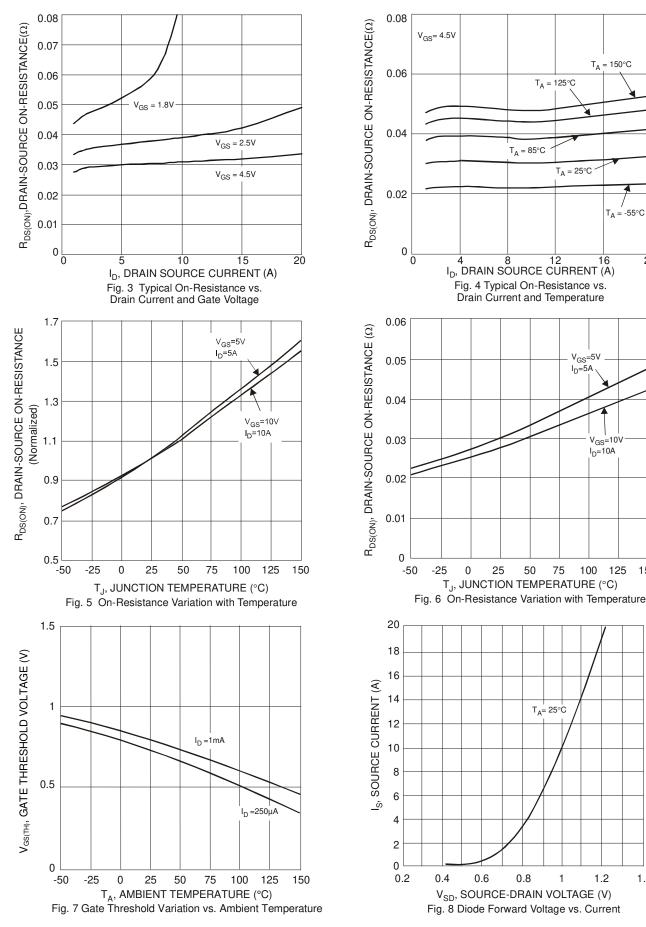
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100 125 150

V_{GS}=10V

I_D=10A



1.4

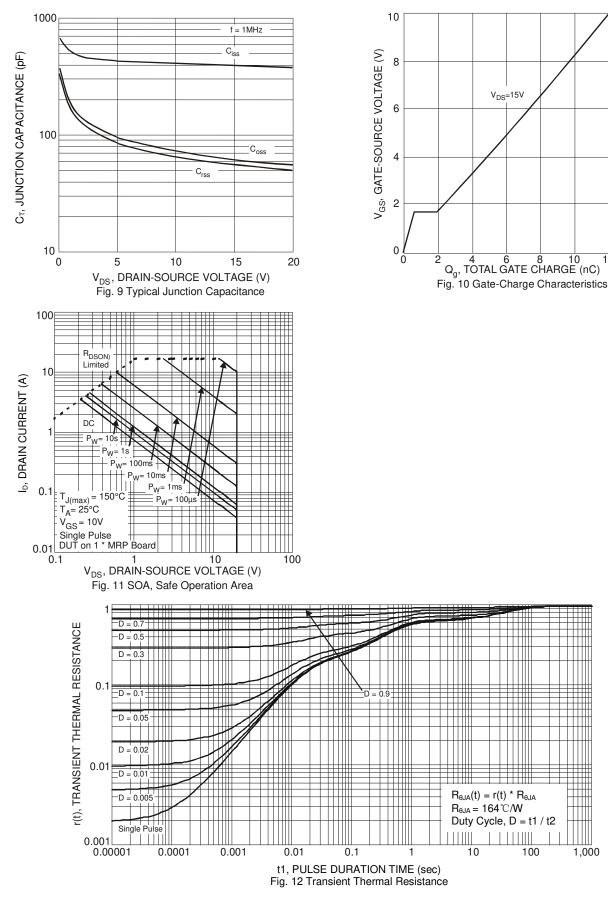
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DMC2038LVT

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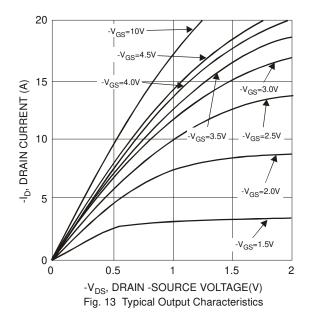


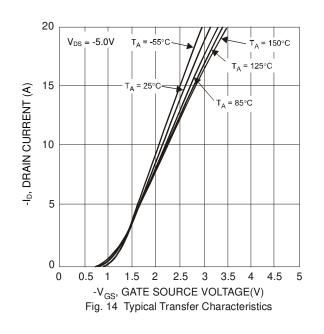


Electrical Characteristics P-CHANNEL – Q2 (@T_A = +25°C, unless otherwise specified.)

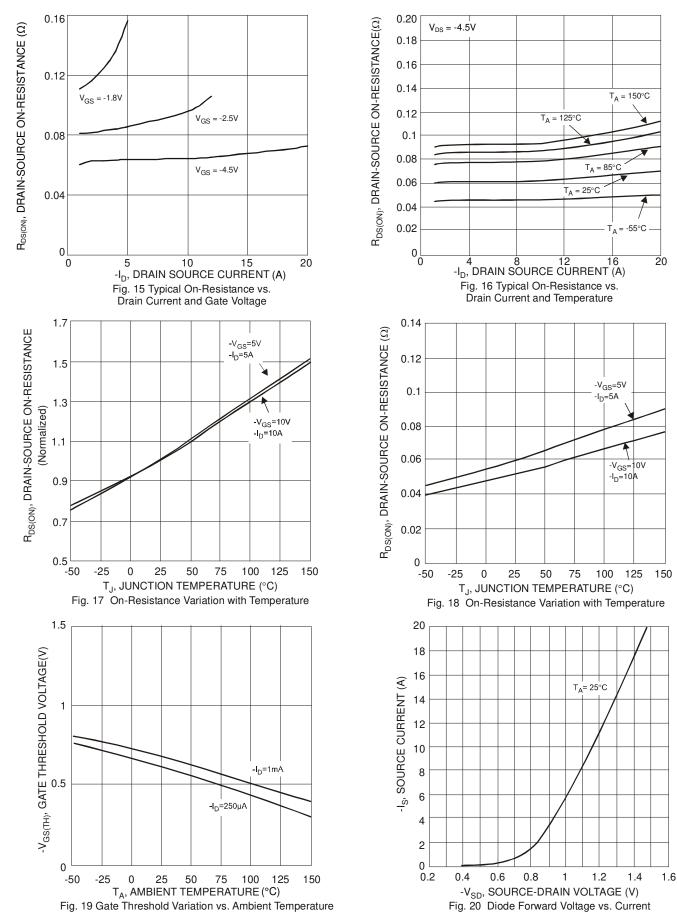
Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)	Cymbol		1.76	Шах	onit	
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	_	V	$V_{GS} = 0V, I_D = -250 \mu A$
Zero Gate Voltage Drain Current @T _C = +25°C	I _{DSS}	_	_	-1.0	μA	$V_{DS} = -16V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	—		±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)				•	•	•
Gate Threshold Voltage	V _{GS(TH)}	-0.4	_	-1.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
		_	57	74		$V_{GS} = -4.5V, I_D = -3.0A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	76	110	mΩ	$V_{GS} = -2.5V, I_D = -1.5A$
		_	102	168		$V_{GS} = -1.8V, I_D = -1.0A$
Forward Transfer Admittance	Y _{fs}		10	—	S	$V_{DS} = -5V, I_D = -3.0A$
Diode Forward Voltage	V _{SD}	—	-0.8	-1.0	V	$V_{GS} = 0V, I_{S} = -0.6A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	—	530	705	pF	
Output Capacitance	Coss	_	70	95	pF	V _{DS} = -10V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	—	60	90	pF	1 - 1.00012
Gate Resistance	Rg	—	72	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	7	10	nC	
Total Gate Charge (V _{GS} = -10V)	Qg	_	14	—	nC	
Gate-Source Charge	Q _{gs}	_	0.95	_	nC	$V_{DS} = -15V, I_D = -6A$
Gate-Drain Charge	Q _{gd}	_	1.2	_	nC	7
Turn-On Delay Time	t _{D(ON)}	—	11	20	ns	
Turn-On Rise Time	t _R	—	12	22	ns	V _{DS} = -10V, V _{GS} = -4.5V,
Turn-Off Delay Time	t _{D(OFF)}	—	21	34	ns	$R_G = 6\Omega$, $I_S = -1A$
Turn-Off Fall Time	tF	_	13	23	ns	1

Notes: 8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing.







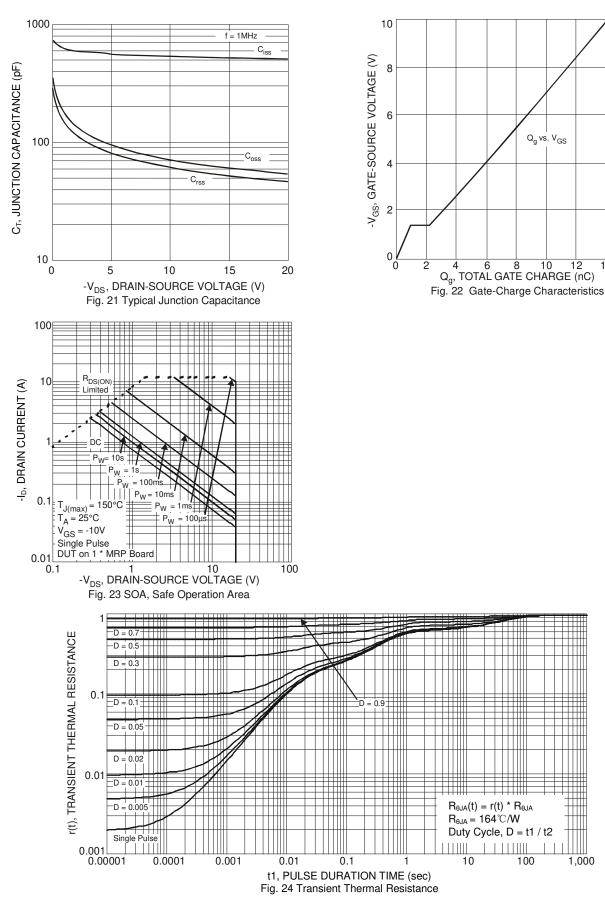


7 of 10 www.diodes.com



14

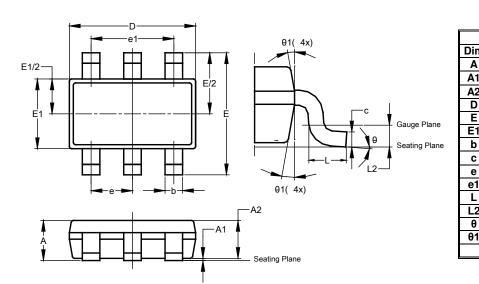
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Package Outline Dimensions

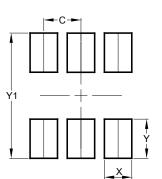
Please see http://www.diodes.com/package-outlines.html for the latest version.



	TSOT26							
Dim	Min	Max	Тур					
Α	-	1.00	-					
A1	0.010	0.100	-					
A2	0.840	0.900	-					
D	2.800	3.000	2.900					
ш	2	2.800 BSC						
E1	1.500	1.700	1.600					
p	0.300	0.450	-					
C	0.120	0.200	-					
е	0	.950 BS	C					
e1	1	.900 BS	C					
L	0.30	0.50	-					
L2	0	.250 BS	C					
θ	0°	8°	4°					
θ1	4°	12°	-					
A	II Dimen	sions in	mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



TSOT26

TSOT26

Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199

Please see http://www.diode



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